# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Young-Soo PARK	03/08/2010
Gi-Jung KIM	03/08/2010
Won-Je PARK	03/08/2010
Jae-Sik BAE	03/08/2010

#### **RECEIVING PARTY DATA**

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State/Country:	REPUBLIC OF KOREA	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12723882

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NAME OF SUBMITTER: Seungman Kim

Total Attachments: 1

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PATENT

REEL: 024080 FRAME: 0262

501119037 REEL: 02

Docket No.: 102-1319

## **U.S. ASSIGNMENT**

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned Inventor(s) (hereinafter, "ASSIGNOR") by (insert Name(s) & Address(es) of ASSIGNEE(S))

SAMSUNG Electronics Co., Ltd. 416 Maetan-dong, Yeongtong-gu Suwon-si, Gyeonggi-do Republic of Korea

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

# METHOD OF FABRICATING EPI-WAFER, EPI-WAFER FABRICATED BY THE METHOD, AND IMAGE SENSOR FABRICATED USING THE EPI-WAFER

relating to International Patent Application PCT was executed on even date herewith or, if not so	
(a) executed on	(Insert date of execution of application, if not concurrent)
(b) filed on	لاستندم
Serial No/	*** Any registered attorney of Stanzione & Kim, LLP, 919 18 <sup>th</sup> Street, N.W., Washington, D.C. 20006, is hereby authorized to insert in section (b) above the specified data, when known.***
substitute, reissue or reexamination application be	the United States granted on said application and any continuation, division, renews sed thereon; for the full term or terms for which the said Letters Patent(s) may be ectively, hereinafter, "said application(s) and Letters Patent(s)").
ASSIGNEE, to do all acts which the ASSIG maintaining and enforcing protection for sai application(s) and the issuance of said Lette proceeding, and in any litigation or other leg	y said ASSIGNEE and without charge to but at the expense of said NEE may deem necessary, desirable or expedient, for securing, d invention, including in the preparation and prosecution of said is Patent(s), in any interference, reissue, reexamination, or public use all proceeding which may arise or be declared in relation to same, such acts papers, including separate assignments and declarations, taking all rightful uning and producing evidence.
IN WITNESS WHEREOF, the undersigned	inventor(s) has (have) affixed his/her/their signature(s).
(Typed Name & Signature of Inventor(s))	(Date)
1) Young-Soo Park Young-Soo PARK	2010-03-08
2) Gi-Jung KIM	2010-03-08
B) Won-Je MEK Won-Je PARK	20/0-03-08
1) Jae Sik Rap	20/0-03-08

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